APPLICA	BLE STAN	DARD									
RATING	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE		-35°C TO +85°C(NO	TE 1)	ТЕМ	DRAGE MPERATURE RANGE -10°C TO +60°C			NOTE 3)		
			40% TO 80% (NOTE 2)			ORAGE JMIDITY RANGE			40% TO 70% (NOTE 3)		
	VOLTAGE		500V AC/DC			PPLICABLE ABLE			UL1007, AWG20-22		
			AWG 20 : 5A AWG 22 : 4A			APPLICABLE CONNECTOR			DF33C-*DS-3. 3C		
			SPEC	IFIC	ATIO	NS					
[TEM		TEST METHOD				R	EQU	IREMENTS	QT	АТ
	RUCTION										
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.				X	
MARKING ELECTRIC CHARA		CTEDISTICS								X	X
CONTACT RESISTANCE		1mA (DC OR 1000 Hz). 20mV MAX				10mΩ MAX. X					1_
INSULATION RESISTANCE		500V DC.				1000ΜΩ ΜΙΝ.				X	1-
VOLTAGE PROOF		1500V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				+	†_
MECHAI	VICAL CHA	RACTI	ERISTICS			<u> </u>				1 * `	1
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.				 CONTACT RESISTANCE: 20mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 10 CYCLE FOR EACH, FOR 3 DIRECTIONS.				 NO ELECTRICAL DISCONTINUITY OF 1μs. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				. X	_
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.								X	_
ENVIRO	NMENTAL		ACTERISTICS								
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			① CONTACT RESISTANCE: 20mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				- I V	_	
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→+85°C TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK IS 2~3 min.			 CONTACT RESISTANCE: 20mΩ MAX. INSULATION RESISTANCE: 1000MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				1 🗸	_	
RESISTANCE TO SOLDERING HEAT		1) AUTOMATIC SOLDERING (FLOW) SOLDERED AT SOLDER TEMPERATURE, 260°C FOR IN IMMERSION, DURATION, 10 s. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE: 300°C,			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.				X	_	
		SOLDERING TIME :3s. NO STRENGTH ON CONTACT.									
SOLDERABILITY		SOLDER	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR IN IMMERSION , DURATION, 5 s.			A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				X	-
NOTE 2:NO (NOTE3:APPL	CONDENSING Y TO THE CONE	DITION OF I	E RISE BY CURRENT. LONGTERM STORAGE FOR UI ID HUMIDITY RANGE IS APPLII			S BEFOR	RE PCB O	N BO	ARD, AFTER PCB BOARD	,	
COUN	NT DI	ESCRIPTI	ON OF REVISIONS		DESIG	SNED	NED		CHECKED		ATE
<u> </u>					ARRONED					10 10 17	
						APPROVED CHECKED		-	KI. AKIYAMA HK. UMEHARA		
						DESIGNED		-			12. 17
Unless otherwise specifid , re			efer to JIS C 5402.			DRAWN		-	MI. SAKIMURA		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test DF					RAWING NO. ELC4-354790-0				0-01		
HS s		PECIFICATION SHEET			PART NO.		DF33C-*DP-3. 3DSA (24)				
	HIR	HIROSE ELECTRIC CO., LTD.				E NO.	CL676- 🔼 1/1				1/1